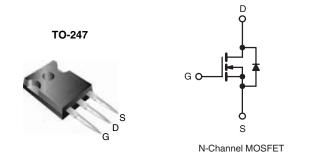


Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	50	500			
$R_{DS(on)}\left(\Omega\right)$	V _{GS} = 10 V	0.40			
Q _g (Max.) (nC)	6	64			
Q _{gs} (nC)	1	16			
Q _{gd} (nC)	26				
Configuration	Sin	Single			



FEATURES

 Low Gate Charge Q_g Results in Simple Drive Requirement



 Improved Gate, Avalanche and Dynamic dV/dt Ruggedness



- Fully Characterized Capacitance and Avalanche Voltage and Current
- Effective Coss Specified
- Lead (Pb)-free Available

APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Uninterruptable Power Supply
- · High Speed Power Switching

TYPICAL SMPS TOPOLOGIES

- Two Transistor Forward
- Half Bridge, Full Bridge
- PFC Boost

ORDERING INFORMATION	
Package	TO-247
Lead (Pb)-free	IRFP450APbF
	SiHFP450A-E3
SnPb	IRFP450A
	SiHFP450A

ABSOLUTE MAXIMUM RATINGS T	$_{\rm C}$ = 25 °C, unless otherw	vise noted		
PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V_{DS}	500	V
Gate-Source Voltage	V_{GS}	± 30	- V	
Continuous Drain Current	V_{GS} at 10 V $T_{C} = 25 ^{\circ}C$ $T_{C} = 100 ^{\circ}C$	I _D	14	А
	V_{GS} at 10 V_{CS} $T_{C} = 100 ^{\circ}C$		8.7	
Pulsed Drain Current ^a	I _{DM}	56	1	
Linear Derating Factor		1.5	W/°C	
Single Pulse Avalanche Energy ^b	E _{AS}	760	mJ	
Repetitive Avalanche Currenta	I _{AR}	14	Α	
Repetitive Avalanche Energy ^a	E _{AR}	19	mJ	
Maximum Power Dissipation	T _C = 25 °C	P_{D}	190	W
Peak Diode Recovery dV/dt ^c	dV/dt	4.1	V/ns	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature)	for 10 s		300 ^d	7
Mounting Torque	6-32 or M3 screw		10	lbf ⋅ in
	0-32 OF IVIS SCIEW		1.1	N⋅m

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Starting T_J = 25 °C, L = 7.8 mH, R_G = 25 $\Omega,\,I_{AS}$ = 14 A (see fig. 12).
- c. $I_{SD} \leq$ 14 A, $dI/dt \leq$ 130 A/µs, $V_{DD} \leq V_{DS}, \, T_J \leq$ 150 °C.
- d. 1.6 mm from case.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply

IRFP450A, SiHFP450A

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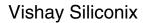


THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	40	
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.24	-	°C/W
Maximum Junction-to-Case (Drain)	R _{thJC}	-	0.65	

PARAMETER	SYMBOL	TEST	TEST CONDITIONS		TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		500	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I _D = 1 mA	-	0.58	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$		2.0	-	4.0	٧
Gate-Source Leakage	I _{GSS}	V _{GS} = ± 30 V		-	-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 5	V _{DS} = 500 V, V _{GS} = 0 V		-	25	μΑ
		V _{DS} = 400 V, \	V _{DS} = 400 V, V _{GS} = 0 V, T _J = 125 °C		-	250	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 8.4 A ^b	-	-	0.40	Ω
Forward Transconductance	9 _{fs}	V _{DS} = 5	60 V, I _D = 8.4 A ^b	7.8	-	-	S
Dynamic							_
Input Capacitance	C _{iss}	$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$ $f = 1.0 \text{ MHz, see fig. 5}$ $V_{GS} = 0 \text{ V}; V_{DS} = 1.0 \text{ V}, f = 1.0 \text{ MHz}$ $V_{GS} = 0 \text{ V}; V_{DS} = 400 \text{ V}, f = 1.0 \text{ MHz}$ $V_{GS} = 0 \text{ V}; V_{DS} = 0 \text{ V to } 400 \text{ V}^c$		-	2038	-	pF
Output Capacitance	C _{oss}			-	307	-	
Reverse Transfer Capacitance	C _{rss}			-	10	-	
Output Capacitance	C _{oss}				2859		
Output Capacitance	C _{oss}				81		
Effective Output Capacitance	Coss eff.				96		
Total Gate Charge	Qg		V _{GS} = 10 V	-	-	64	nC
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V		-	-	16	
Gate-Drain Charge	Q _{gd}	1	occ ng. c and re	-	-	26	
Turn-On Delay Time	t _{d(on)}		V 050 V I 14 A		15	-	- ns
Rise Time	t _r	V 2			36	-	
Turn-Off Delay Time	t _{d(off)}	$V_{DD} = 250 \text{ V}, I_{D} = 14 \text{ A},$ $R_{G} = 6.2 \Omega, R_{D} = 17 \Omega, \text{ see fig. } 10^{\text{b}}$		-	35	-	
Fall Time	t _f			-	29	-	
Drain-Source Body Diode Characteristic	s					<u>'</u>	
Continuous Source-Drain Diode Current	Is	MOSFET symbol showing the integral reverse p - n junction diode		-	-	14	A
Pulsed Diode Forward Current ^a	I _{SM}			_	-	56	_ ^
Body Diode Voltage	V_{SD}	$T_J = 25 ^{\circ}\text{C}, \ I_S = 14 \text{A}, \ V_{GS} = 0 \text{V}^{\text{b}}$		-	-	1.4	V
Body Diode Reverse Recovery Time	t _{rr}	T _J = 25 °C, I _F = 14 A, dl/dt = 100 A/μs ^b		-	487	731	ns
Body Diode Reverse Recovery Charge	Q _{rr}			-	3.9	5.8	μС
Forward Turn-On Time	t _{on}	Intrinsic turn	on time is negligible (turn	on is dor	ninated b	y L _S and	L _D)

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width \leq 300 μ s; duty cycle \leq 2 %. c. C_{oss} eff. is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80 % V_{DS} .





TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

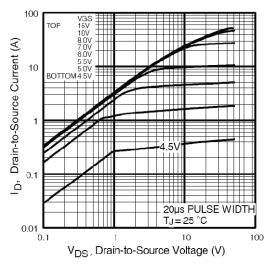


Fig. 1 - Typical Output Characteristics

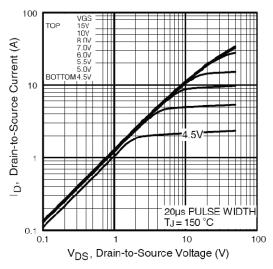


Fig. 2 - Typical Output Characteristics

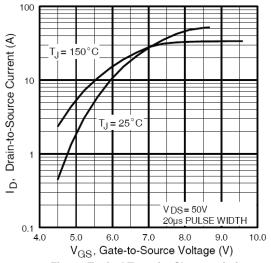


Fig. 3 - Typical Transfer Characteristics

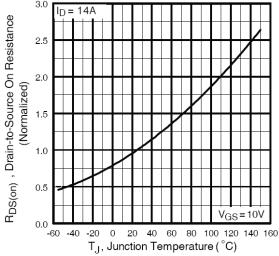


Fig. 4 - Normalized On-Resistance vs. Temperature

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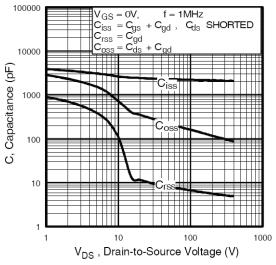


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

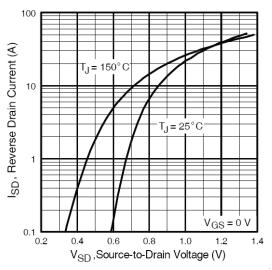


Fig. 7 - Typical Source-Drain Diode Forward Voltage

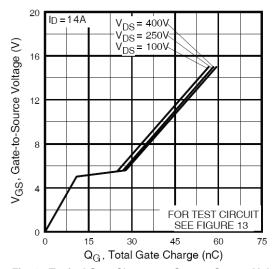


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

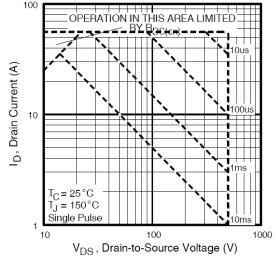


Fig. 8 - Maximum Safe Operating Area





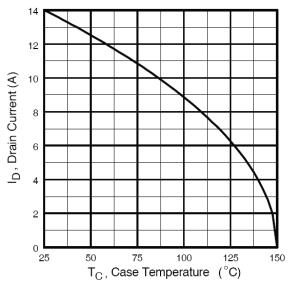


Fig. 9 - Maximum Drain Current vs. Case Temperature

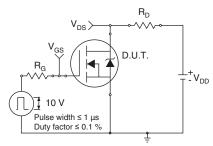


Fig. 10a - Switching Time Test Circuit

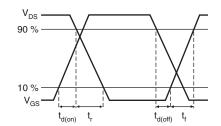


Fig. 10b - Switching Time Waveforms

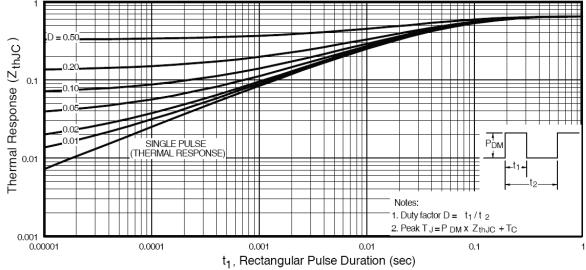


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

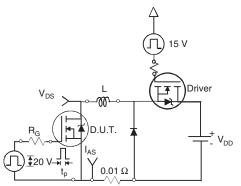


Fig. 12a - Unclamped Inductive Test Circuit

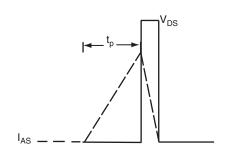


Fig. 12b - Unclamped Inductive Waveforms

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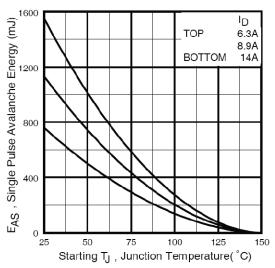


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

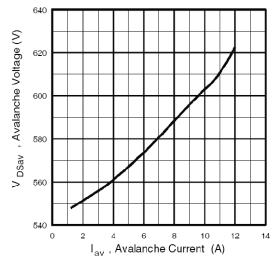


Fig. 12d - Typical Drain-to-Source Voltage vs.
Avalanche Current

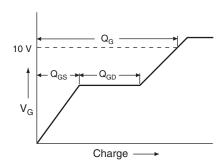


Fig. 13a - Basic Gate Charge Waveform

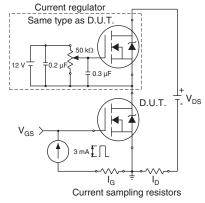
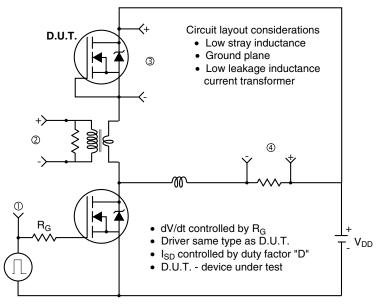
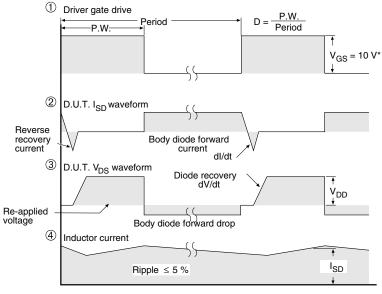


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit





* V_{GS} = 5 V for logic level devices

Fig. 14 - For N-Channel

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